

2SD1205, 2SD1205A

Silicon NPN epitaxial planer type darlington

For low-frequency amplification

Features

- Forward current transfer ratio h_{FE} is designed high, which is appropriate to the driver circuit of motors and printer bammer: $h_{FE} = 4000$ to 2000 .
- A shunt resistor is omitted from the driver.
- M type package allowing easy automatic and manual insertion as well as stand-alone fixing to the printed circuit board.

Absolute Maximum Ratings ($T_a=25^\circ\text{C}$)

Parameter	Symbol	Ratings	Unit
Collector to base voltage	V_{CBO}	30	V
		60	
Collector to emitter voltage	V_{CEO}	25	V
		50	
Emitter to base voltage	V_{EBO}	5	V
Peak collector current	I_{CP}	750	mA
Collector current	I_C	500	mA
Collector power dissipation	P_C	400	mW
Junction temperature	T_j	150	$^\circ\text{C}$
Storage temperature	T_{stg}	$-55 \sim +150$	$^\circ\text{C}$

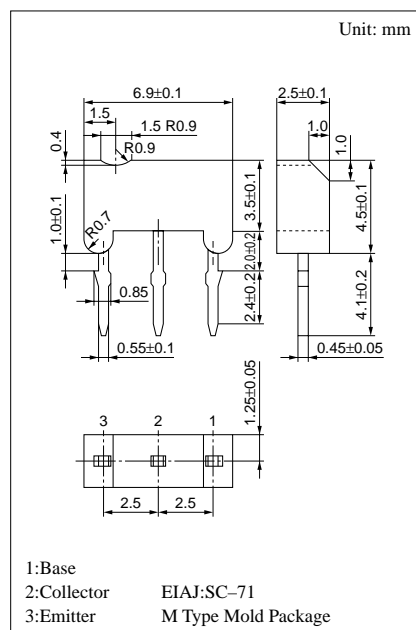
Electrical Characteristics ($T_a=25^\circ\text{C}$)

Parameter	Symbol	Conditions	min	typ	max	Unit
Collector cutoff current	I_{CBO}	$V_{CB} = 25\text{V}, I_E = 0$			100	nA
Emitter cutoff current	I_{EBO}	$V_{EB} = 4\text{V}, I_C = 0$			100	nA
Collector to base voltage	V_{CBO}	$I_C = 100\mu\text{A}, I_E = 0$	30			V
			60			
Collector to emitter voltage	V_{CEO}	$I_C = 1\text{mA}, I_B = 0$	25			V
			50			
Emitter to base voltage	V_{EBO}	$I_E = 100\mu\text{A}, I_C = 0$	5			V
Forward current transfer ratio	h_{FE}^{*1}	$V_{CE} = 10\text{V}, I_C = 500\text{mA}^{*2}$	4000		20000	
Collector to emitter saturation voltage	$V_{CE(sat)}$	$I_C = 500\text{mA}, I_B = 0.5\text{mA}^{*2}$			2.5	V
Base to emitter saturation voltage	$V_{BE(sat)}$	$I_C = 500\text{mA}, I_B = 0.5\text{mA}^{*2}$			3	V
Transition frequency	f_T	$V_{CB} = 10\text{V}, I_E = -50\text{mA}, f = 200\text{MHz}$		150		MHz

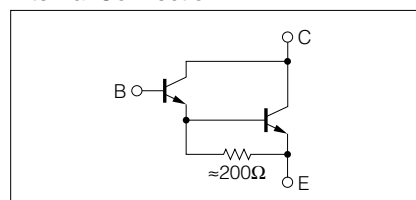
^{*1} h_{FE} Rank classification

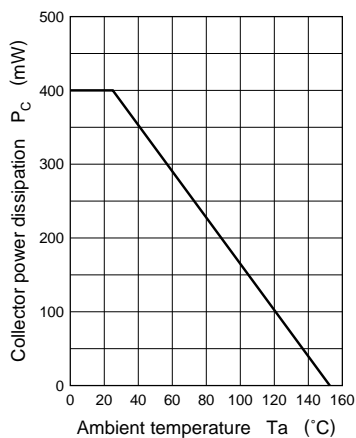
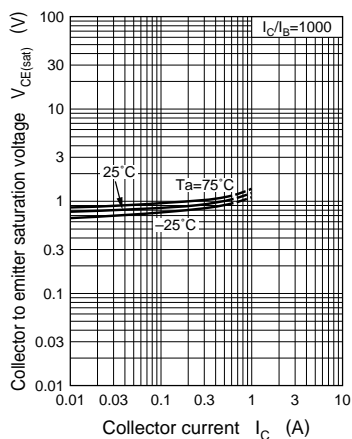
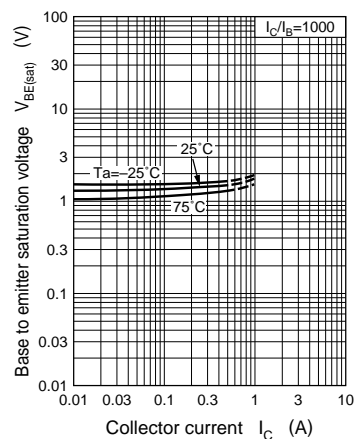
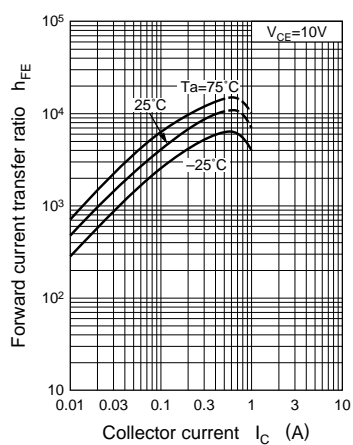
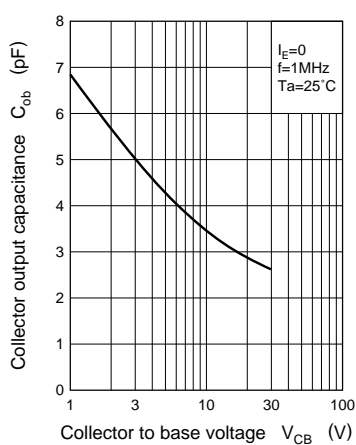
Rank	Q	R
h_{FE}	4000 ~ 10000	8000 ~ 20000

^{*2} Pulse measurement



Internal Connection



$P_C - T_a$  $V_{CE(sat)} - I_C$  $V_{BE(sat)} - I_C$  $h_{FE} - I_C$  $C_{ob} - V_{CB}$ 

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